

SCT3105KR

N-channel SiC power MOSFET

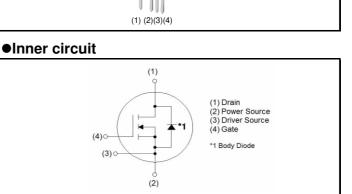
V _{DSS}	1200V
R _{DS(on)} (Typ.)	105mΩ
۱ _D *1	24A
P _D	134W

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

•Outline TO-247-4L

	Packing	Tube
	Reel size (mm)	-
Tuno	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	30
	Taping code	C15
	Marking	SCT3105KR

●Absolute maximum ratings (T_{vi} = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		V _{DSS}	1200	V
Continuous Drain current	$T_c = 25^{\circ}C$	ا _D *1	24	A
Continuous Drain current	$T_c = 100^{\circ}C$	ا _D *1	17	A
Pulsed Drain current (T _c = 25°C)		I _{D,pulse} *2	60	A
Gate - Source voltage (DC)		V _{GSS}	-4 to +22	V
Gate - Source surge voltage (t _{surge} < 300ns)		*3 V _{GSS_surge}	-4 to +26	V
Recommended drive voltage		V _{GS_op} ^{*4}	0 / +18	V
Virtual Junction temperature		T _{vj}	175	°C
Range of storage temperature		T _{stg}	-55 to +175	°C

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•Electrical characteristics ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

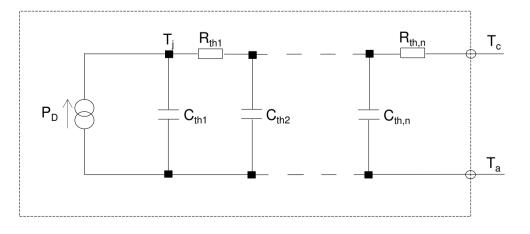
Devementer	Cumbal	nhol Conditiona		Values		
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit
		$V_{GS} = 0V, I_D = 1mA$				
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$T_{vj} = 25^{\circ}C$	1200	-	-	V
		$T_{vj} = -55^{\circ}C$	1200	-	-	
		$V_{GS} = 0V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	I _{DSS}	$T_{vj} = 25^{\circ}C$	-	1	10	μA
		$T_{vj} = 150^{\circ}C$	-	2	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +22V, \ V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS (th)}$	$V_{DS} = 10V, I_{D} = 3.81mA$	2.7	-	5.6	V
		$V_{GS} = 18V, I_{D} = 7.6A$				
Static Drain - Source on - state resistance	${\sf R}_{\sf DS(on)}$ *5	$T_{vj} = 25^{\circ}C$	-	105	137	mΩ
		T _{vj} = 150°C	-	179	-	
Gate input resistance	R_G	f = 1MHz, open drain	-	13	-	Ω

•Thermal resistance

Parameter	Symbol	Values			Unit
i arameter	Symbol	Min.	Тур.	Max.	Onit
Thermal resistance, junction - case	R _{thJC}	-	0.86	1.12	K/W

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	1.14×10 ⁻¹		C _{th1}	5.02×10 -4	
R _{th2}	5.07×10 ⁻¹	K/W	C _{th2}	4.91×10 ⁻³	Ws/K
R _{th3}	2.51×10 ⁻¹		C _{th3}	4.99×10 -2	-





•Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

Deremeter	Symbol	Conditions	Values			L Locit
Parameter	Symbol	nbol Conditions		Тур.	Max.	Unit
Transconductance	g _{fs} *5	$V_{DS} = 10V, I_{D} = 7.6A$	-	3.4	-	S
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	574	-	
Output capacitance	C _{oss}	V _{DS} = 800V	-	59	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	28	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 600V	-	159	-	pF
Total Gate charge	Q_g^{*5}	$V_{DS} = 600V$ $I_{D} = 7.6A$	-	51	-	
Gate - Source charge	Q _{gs} *5	$V_{\rm GS} = 18V$	-	10	-	nC
Gate - Drain charge	Q _{gd} *5	See Fig. 1-1.	_	25	-	
Turn - on delay time	t _{d(on)} *5	$V_{DS} = 600V$	-	4	-	
Rise time	tr ^{*5}	$I_{\rm D} = 12 {\rm A}$ $V_{\rm GS} = 0 {\rm V}/+18 {\rm V}$	-	12	-	
Turn - off delay time	t _{d(off)} *5	$R_{G} = 0\Omega, L = 750 \mu H$ L _σ = 50nH, C _σ = 10pF	-	15	-	ns
Fall time	t _f *5	See Fig. 2-1, 2-2, 2-3.	-	11	-	
Turn - on switching loss	E _{on} *5	E _{on} includes diode reverse recovery.	-	134	-	1
Turn - off switching loss	${\sf E_{off}}^{*5}$		-	10	-	μJ



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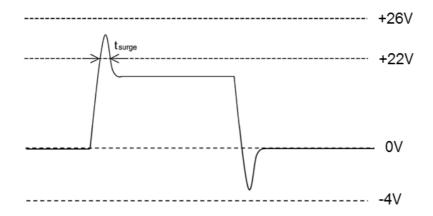
●Body diode electrical characteristics (Source-Drain) (T_{vj} = 25°C unless otherwise specified)

Parameter	Symbol	bol Conditions		Values		
Farameler	Зушоо	Conditions	Min.	Тур.	Max.	Unit
Body diode continuous, forward current	ا _S *1	T _c = 25°C	-	-	24	А
Body diode direct current, pulsed	I _{SM} *2	T _c = 25 0	-	-	60	А
Forward voltage	V_{SD} *5	$V_{GS} = 0V, I_{S} = 7.6A$	I	3.2	I	V
Reverse recovery time	t _{rr} *5	$I_{\rm F} = 7.6 {\rm A}$ $V_{\rm B} = 600 {\rm V}$	-	13	-	ns
Reverse recovery charge	Q _{rr} *5	v _R = 000∨ di/dt = 2500A/µs	-	175	-	nC
Peak reverse recovery current	I _{rrm} *5	L_{σ} = 50nH, C_{σ} = 10pF See Fig. 3-1, 3-2.	-	22	-	А

*1 Limited by maximum T_{vj} and for Max. R_{thJC} .

*2 PW \leq 10µs, Duty cycle \leq 1%

*3 Example of acceptable V_{GS} waveform

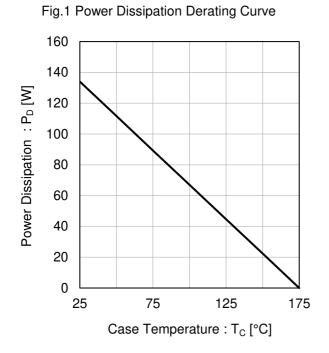


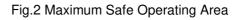
Please note especially when using driver source that $V_{\text{GSS_surge}}$ must be in the range of absolute maximum rating.

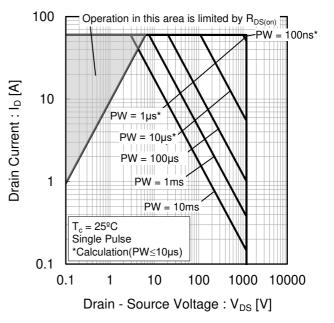
*4 Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.

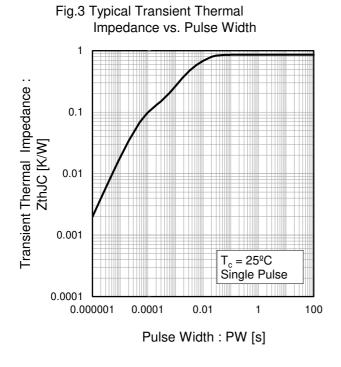
*5 Pulsed





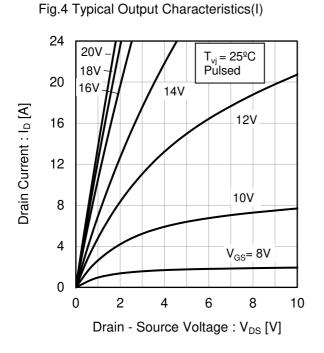






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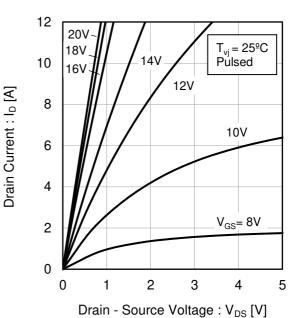
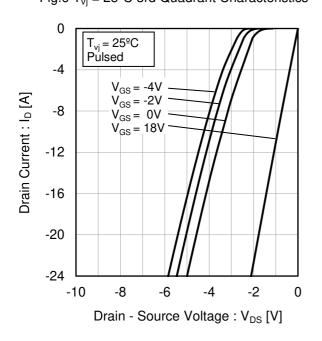


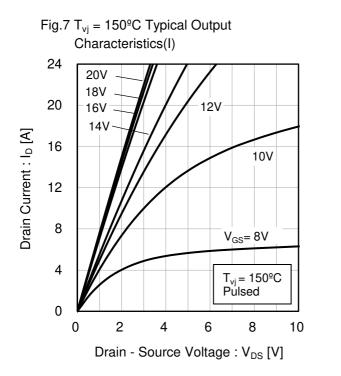
Fig.5 Typical Output Characteristics(II)

Fig.6 $T_{vj} = 25^{\circ}C$ 3rd Quadrant Characteristics



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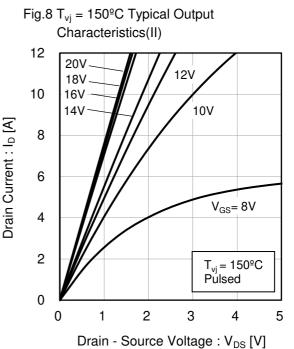


Fig.9 T_{vj} = 150°C 3rd Quadrant Characteristics

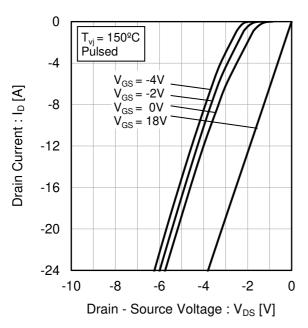
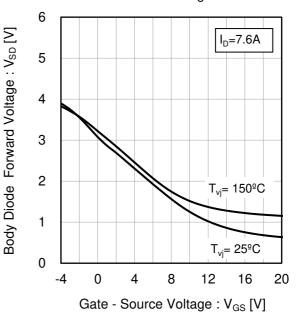
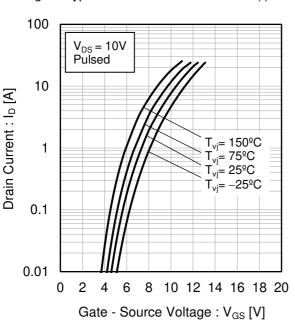


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage







24 $V_{DS} = 10V$ Pulsed 20 Drain Current : I_D [A] 16 T_{vj}= 150⁰C 12 T_{vj}= 75⁰C T_{vj}= 25ºC 8 T_{vj}= −25ºC 4 0 2 4 6 8 10 12 14 16 18 20 0 Gate - Source Voltage : V_{GS} [V]

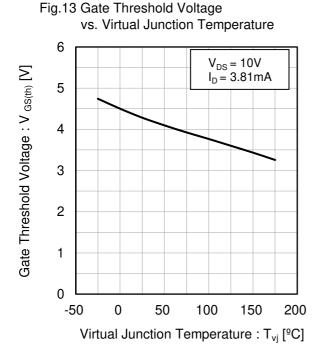


Fig.14 Transconductance vs. Drain Current

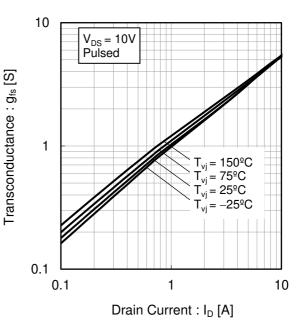
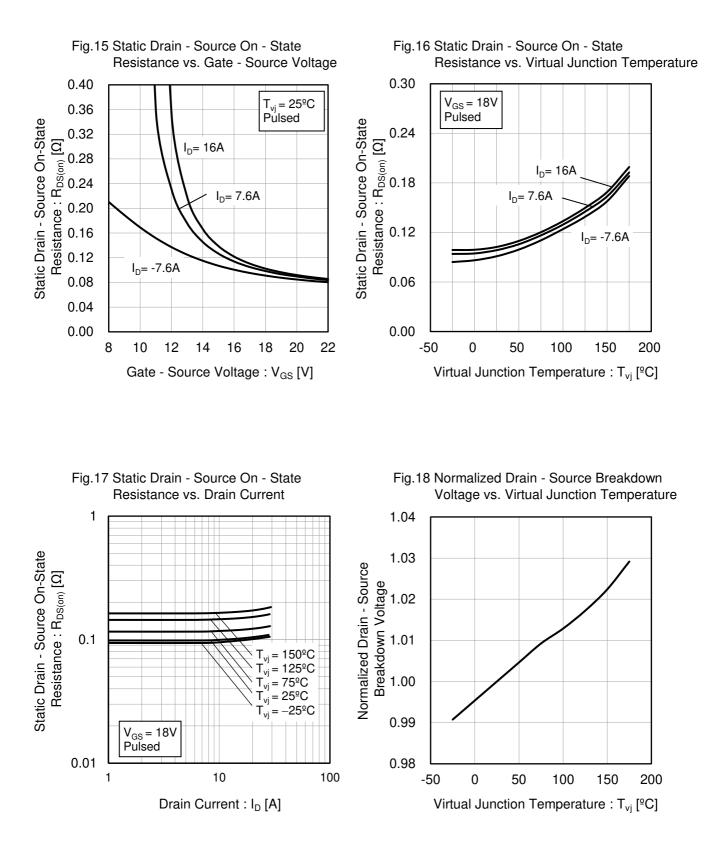


Fig.11 Typical Transfer Characteristics (I)

Fig.12 Typical Transfer Characteristics (II)







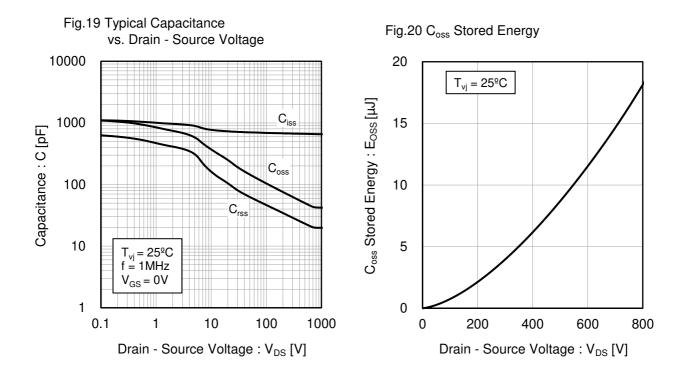
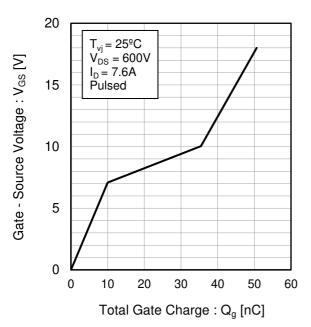
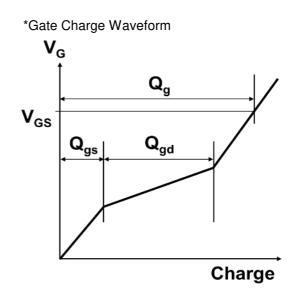


Fig.21 Dynamic Input Characteristics

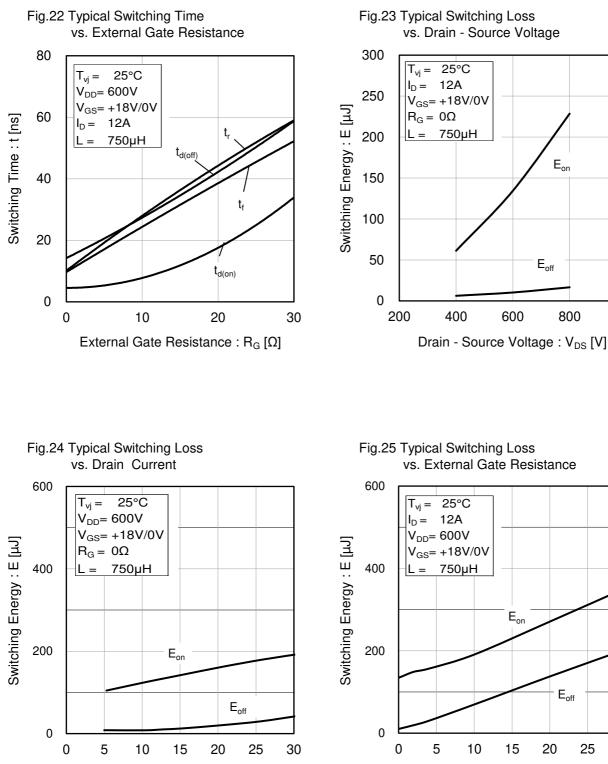






1000

Electrical characteristic curves



External Gate Resistance : $R_G [\Omega]$

Drain Current : I_D [A]



30

25

Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

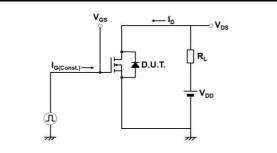


Fig.2-1 Switching Characteristics Measurement Circuit

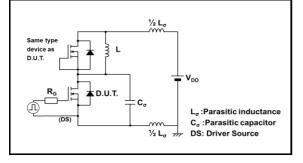


Fig.2-3 Waveforms for Switching Energy Loss

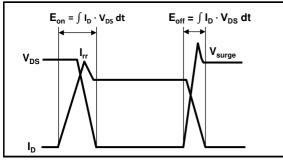


Fig.3-1 Reverse Recovery Time Measurement Circuit

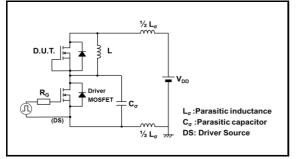


Fig.2-2 Waveforms for Switching Time

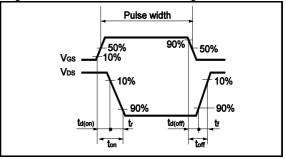
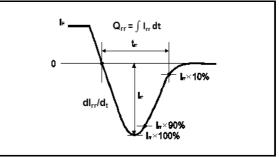
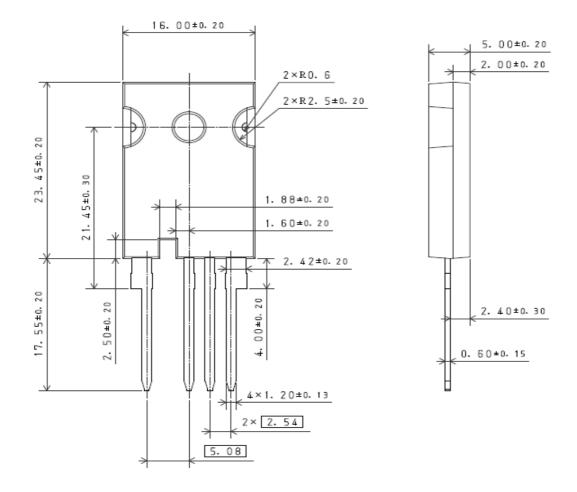


Fig.3-2 Reverse Recovery Waveform



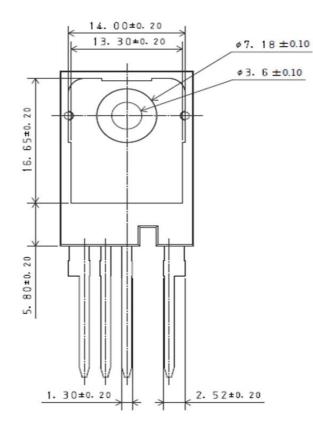


Package Dimensions



Unit: mm

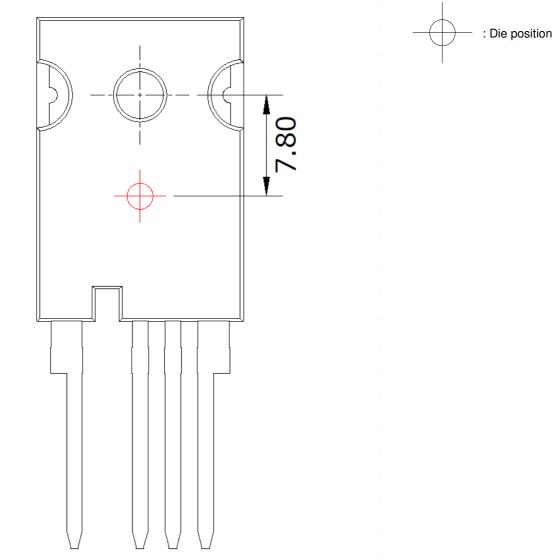




Unit: mm



Die Bonding Layout



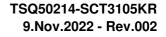
• Front view of the packaging.

•Dimensions are design values.

• If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm





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